

RX Family

QE Touch module Firmware Integration Technology

Introduction

This application note describes the TOUCH Module.

Target Device

- · RX113 Group
- RX130 Group
- · RX230 Group
- · RX231 Group
- RX23W Group
- · RX671 Group
- RX140 Group
- RX260 Group
- · RX261 Group

When using this application note with other Renesas MCUs, careful evaluation is recommended after making modifications to comply with the alternate MCU.

Related Documents

QE Touch Diagnostic API Users' Guide (R01AN4785EU)
Firmware Integration Technology User's Manual (R01AN1833)
Board Support Package Firmware Integration Technology Module (R01AN1685)
Adding Firmware Integration Technology to Projects (R01AN1723)
RX100 Series VDE Certified IEC60730 Self-Test Code (R01AN2061ED)
RX v2 Core VDE Certified IEC60730 Self-Test Code for RX v2 MCU (R01AN3364EG)

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1. Overview

The TOUCH Module is middleware that uses the CTSU module to provide capacitive touch detection. The TOUCH module assumes access from the user application is possible.

1.1 Functions

The TOUCH module supports the following functions.

1.1.1 QE for Capacitive Touch Usage

Similar to the CTSU module, this module provides various capacitive touch detections based on configuration settings generated by QE for Capacitive Touch (referred to as QE)

As a part of the configuration settings, the touch interface configuration displays configuration information for the CTSU link information and buttons, sliders, and wheels. A multiple touch interface configuration is necessary when both self and mutual capacitance buttons are used in the same product or when using the active shield function.

This module also supports the QE monitor function. The monitor determines whether to use debugger or serial communications, determines the type of information from QE and sends only the necessary information.

This module also supports QE serial tuning function. Sensor drive pulse frequency, measurement time and threshold are determined by connecting to QE with UART communication.

1.1.2 Measurements and Data Processing

The module determines whether the button has been touched based on the change in capacitance and detects the position of the slider or wheel. This requires continued periodic measurements of capacitance. When developing your application, make sure to periodically call R_TOUCH_ScanStart() and R_TOUCH_DataGet(). For more details, refer to the sample application.

CTSU2L has two types of majority judgement mode, JMM (Judgement Majority Mode) and VMM (Value Majority Mode). JMM gathers three measured values to one button from CTSU module, and determines touch state for each measured value, then creates final touch state by majority vote of three touch state. VMM creates touch state from summed value out of three measured values at CTSU module.

VMM is only available for sliders and wheels.

Please refer to the APN of CTSU module to see the details of JMM and VMM. RX140, RX260 and RX261 are equipped with CTSU2L.

1.1.3 Button Touch Determination

Touch determination features and its explanations are described in(a)~(f).

(a) Creating reference value and threshold

First, a reference value is created based on measurement results in the non-touch state. The initial reference value is the first measured value. The threshold is then determined with an arbitrary offset. If a measured value exceeds the threshold, the button is determined to be in the ON state, if it does not exceed the threshold, it is in the OFF state.

Processing for self-capacitance and mutual capacitance are basically the same. However, because the amount of capacitance decreases when a mutual capacitance button is touched, the user needs to set the threshold based on decreasing measured values to determine the ON/OFF state.

You can set the threshold for each button separately in the configuration settings (threshold in touch_button_cfg). The following functions are also included to deal with issues such as chattering suppression and changes in the external environment which affect actual touch recognition.



(b) Positive Noise Filter/Negative Noise Filter

As a chattering countermeasure, you can confirm the ON/OFF state after a set number of consecutive ON or OFF determinations.

In the configuration settings (on_freq and off_freq in touch_cfg_t) set the number of consecutive ON or OFF states. You can do this for all buttons in the touch interface configuration. Be aware that, although this is an effective solution to improving chattering, the greater the number of consecutive states, the slower the response to actual touch.

(c) Hysteresis

This is another chattering countermeasure. Offset the constant to the threshold after the state goes to ON, and prevent chattering by using hysteresis as the OFF-to-ON and ON-to-OFF threshold.

You can set the hysteresis value for each button in the configuration settings (hysteresis in touch_button_cfg_t). The larger the hysteresis, the more effective the countermeasure is in suppressing chattering. However, keep in mind that this will make it more difficult to return the state from ON-to-OFF of OFF-to-ON.

(d) Chattering suppression type (Build option)

This build option is a function to supplement the above functions (Positive Noise Filter/Negative Noise Filter and Hysteresis) for performing touch judgment.

This build option changes the processing method for Counter of exceed threshold to TypeA or TypeB.

TypeA of chattering suppression: Counter of exceed threshold is hold within hysteresis range.

TypeB of chattering suppression: Counter of exceed threshold is reset within hysteresis range.

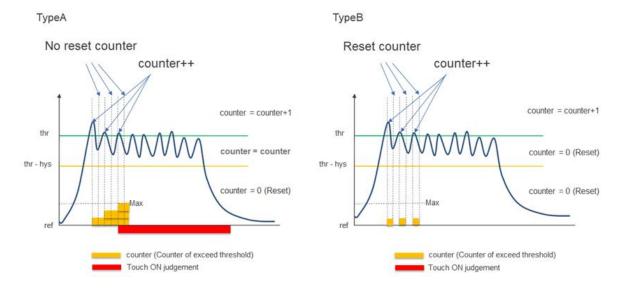


Figure 1 Example of chattering suppression operation

(e) Drift Correction Process

As a countermeasure for changes in the external environment, the drift correction process refreshes the reference value.

After averaging the measured value in the OFF state over a set period, if the button is in the touch OFF state after a set period, the reference value is refreshed. The drift correction is only executed in the OFF state and is cleared when touch ON is determined.

Set the period in the configuration settings (drift_freq in touch_cfg_t). You can do this for all buttons in the touch interface configuration. This allows you to adjust the ability to determine the touch state despite changes in the external environment.

Figure 2 shows an example of the drift correction process.

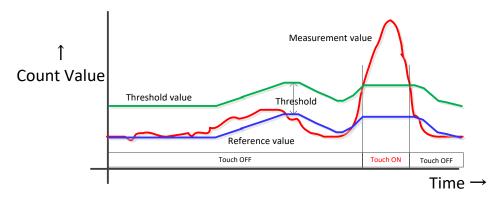


Figure 2 Button Touch Determination

(f) Press and hold cancel

Strong noise or other sudden environment changes can disable the drift correction process, preventing return from the ON state. The press and hold cancel function implements the drift correction process and returns the button from the ON state by forcibly turning the state to OFF after a certain number of consecutive ON state periods.

Set the number of consecutive ON periods required for the press and hold cancel function to return the button to the OFF state in the configuration settings (cancel_freq in touch_cfg_t). You can do this for all buttons in the touch interface configuration.

1.1.4 Touch Position Detection of Slider/Wheel

Configure a slider with multiple terminals to be measured (TS) physically arranged in a straight line. Configure a wheel with multiple terminals physically arranged in a circle.

The touch position is calculated from the measured values of the TS in the configuration. The calculation method for sliders and wheels is fundamentally the same.

- 1. Detect the maximum value (TS_MAX) among the terminals in the configuration.
- 2. Calculate the difference (d1, d2) between TS_MAX and the terminals on either side. (If the TS_MAX terminal is at one end of the slider, use the values of the two terminals to the right or left, accordingly.)
- 3. If the total of d1 and d2 exceeds the threshold, position calculation is initiated. If the total amount does not exceed the threshold, the position calculation process is ended.

With TS_MAX as the middle position, the ratio of d1 to d2 is used to calculate the position. The slider has a range of 1 to 100, and the while has a range of 1 to 360.

1.1.5 Tuning the Touch Determination Threshold

In cases where the amount of change in measurement value in response to touching varies due to changes in the environment, this function allows the user program to dynamically adjust the thresholds for judging the state of touch instead of requiring re-tuning through the QE tool.

The RM_TOUCH_SensitivityRatioGet() and RM_TOUCH_ThresholdAdjust() API functions are provided for this purpose. The pointer member of the structure shown in Table 1 is passed through the second argument of these API functions.

Table 1 touch_sensitivity_info_t Structure

Data Type	Member Name	Description
uint16_t *	p_touch_sensitivity_ratio	Pointer to the array holding the ratios of changes in response to touching
uint16_t	old_threshold_ratio	Old threshold ratio
uint16_t	new_threshold_ratio	New threshold ratio
uint8_t	new_hysteresis_ratio	New hysteresis ratio

Obtaining the Ratio of Change in Response to Tuning

The measurement value is compared with the reference value. If the measurement value is smaller, the ratio of change in response to touching is set to 0. If the measurement value is larger, the ratio of change in response to touching is calculated and output. The RM_TOUCH_SensitivityRatioGet() API function is provided for this purpose.

Ratio of change in response to touching

= (measurement value – reference value) × new threshold ratio ÷ old threshold

Adjusting the Threshold and Hysteresis by Changing the Ratios

The middleware receives the old threshold ratio, a new threshold ratio, and a new hysteresis ratio from the user program and changes the threshold and hysteresis. The RM_TOUCH_ThresholdAdjust() API function is provided for this purpose. The default threshold determined by QE tuning is 60% of the ratio of change by touching. To change the ratios based on this value, set old_threshold_ratio to 60.

New threshold = old threshold \times new threshold ratio \div old threshold ratio

New hysteresis = new threshold \times new hysteresis ratio

In addition, the middleware has a function for adjustment by using the ratio of change in response to touching. Use of the result obtained by the function described in "Obtaining the Ratio of Change in Response to Tuning" is recommended. When not using this function, set the ratio of change in response to touching to 100.

The middleware receives the ratio of change in response to touching from the user program and changes the threshold accordingly.

New threshold = desired threshold × current ratio of change by touching

The new threshold is used to adjust the hysteresis.

New hysteresis = new hysteresis ratio × new threshold



[Example 1] When preventing errors in judgement due to EMC noise is to given priority over the touch sensitivity

The default threshold determined by QE tuning is 60% of the amount of change in response to touching. This value is adjusted to 70%.

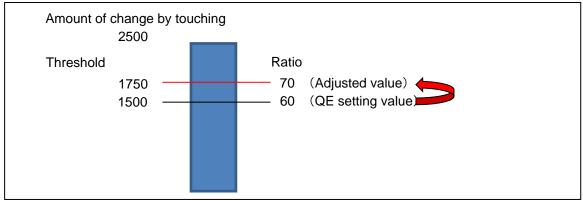


Figure 3 Example of Adjusting the Threshold by Changing the Ratios

In this case, set the members of the touch_sensitivity_info_t structure as follows.

*p_touch_sensitivity_ratio = 100, old_threshold_ratio = 60, new_threshold_ratio = 70 and new_hysteresis_ratio = 5.

[Example 2] When the type of the overlay panel has been changed but re-tuning by the QE tool is not possible

When the overlay panel used is thicker than that used in tuning, the amount of change in response to touching becomes smaller. Therefore, if the software is used without re-tuning, judgement of the touched state may not be possible. In such cases, the threshold for judgement of the touched state is adjusted by using the ratio of the amount of change in response to touching after the overlay panel has been changed to the amount of change at the time of tuning.

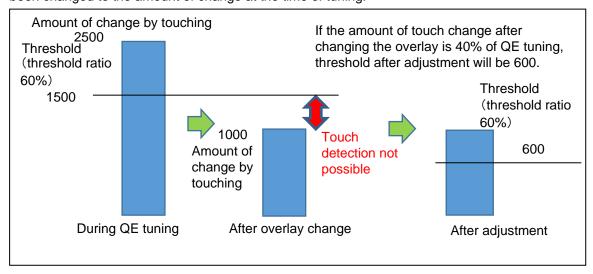


Figure 4 Example of Adjusting the Threshold according to the Touch Measurement Results

In this case, set the members of the touch_sensitivity_info_t structure as follows.

*p_touch_sensitivity_ratio = 40, old_threshold_ratio = 60, new_threshold_ratio = 60 and new hysteresis ratio = 5

[Practical Example] Tuning application without either retuning or rewriting the software

This is an example of the application for adjustment using data flash without re-tuning or software rewriting. Enable UART communication to PC and 'tuning mode'. In tuning mode, the MCU transmits the ratio of touch sensitivity in the touch state to the PC in real time. A user sends a command to decide the ratio while monitoring on the PC. The MCU stores the received ratio in the data flash. Make sure that the ratio stored in the data flash is read at the software activation, and the touch determination threshold is adjusted based on this stored value.

1.2 API Overview

The TOUCH module includes the following functions.

Function	Description
RM_TOUCH_Open()	Initializes the specified touch interface configuration.
RM_TOUCH_ScanStart()	Starts measurement of specified touch interface configuration.
RM_TOUCH_DataGet()	Gets measured values of specified touch interface configuration.
RM_TOUCH_CallbackSet()	Sets callback function of specified touch interface configuration.
RM_TOUCH_Close()	Closes specified touch interface configuration.
RM_TOUCH_ScanStop()	Stops measuring the specified touch interface configuration.
RM_TOUCH_SensitivityRatioGet()	Gets the ratio of the current touch sensitivity compare to change in response to tuning to specified touch interface configuration.
RM_TOUCH_ThresholdAdjust()	Adjust the ratio of touch determination threshold and the hysteresis value to specified touch interface configuration.
RM_TOUCH_DriftControl()	Changes drift correction settings.
RM_TOUCH_MonitorAddressGet()	Gets the address of the variable used for the QE monitor.

2. API Information

Operations of this FIT module have been confirmed under the following conditions.

2.1 Hardware Requirements

The MCU used in the development must support one of the following functions:

- CTSU
- CTSUa
- CTSU2L
- CTSU2SL
- CTSU2SLa

2.2 Software Requirements

This driver depends on the following FIT modules:

- Board support package (r_bsp) v7.50 or newer
- QE CTSU FIT Module (r_ctsu_qe) v3.00
- SCI module (r_sci_rx) v5.20 or newer
- RSCI module (r_rsci_rx) v2.50 or newer

The driver also assumes the use of the following tool:

QE for Capacitive Touch V4.0.0 (capacitive touch sensor development support tool) or newer

2.3 Supported Toolchains

This FIT module has been confirmed with the development environment and compiler shown below.

Development environment

- Renesas e² studio 2024-07
- IAR Embedded Workbench for Renesas RX 5.10.1

Compiler

- Renesas CC-RX Toolchain v.3.06.00
- GCC RX Toolchain v8.3.0.202405
- IAR C/C++ Compiler for Renesas RX version 5.10.1

2.4 Restrictions

The module code is non-reentrant and protects simultaneous calls for multiple functions.

2.5 Header File

All interface definitions to be called and used in the API are defined in "rm_touch_qe.h".

Select "rm_touch_qe_config.h" as the configuration option in each build.

2.6 Integer Type

This driver uses ANSI C99. The types are defined in stdint.h.



2.7 Compilation Settings

The following table provides the names and setting values for the configuration option settings used the TOUCH module.

rm_touch_co	rm_touch_config.h Configuration Options			
TOUCH_CFG_PARAM_CHECKING_ENABLE	Selects whether to include the parameter check process in the			
*Default value:	code.			
"BSP_CFG_PARAM_CHECKING_ENABLE"	Selecting "0" allows the user to omit the parameter check process			
	from the code to shorten the code size.			
	"0": Omit parameter check process from code.			
	"1": Include parameter check process in code.			
	"BSP_CFG_PARAM_CHECKING_ENABLE": Selection depends on BSP setting.			
TOUCH_CFG_MONITOR_ENABLE	Select 1 to enable data generation for the QE monitor.			
This option is not available for rm_touch_config.h.				
The option is defined in the qe_touch_define.h				
output by the QE; the default value is "1".				
TOUCH_CFG_UART_MONITOR_SUPPORT *Default value: "0"	This option is used when TOUCH_CFG_MONITOR_ENABLE is enabled.			
	Set to "1" to enable QE and serial communications.			
	Note:			
	When using the UART module, generate this option with the Smart			
	Configurator.			
TOUCH_CFG_UART_TUNING_SUPPORT	Set the use of UART tuning. 0: Disable, 1: Enable			
TOUCH_CFG_UART_MODULE_TYPE	Select FIT module wich control UART.			
*Default value: "0"	Set "0", UART use of SCI module (r_sci_rx).			
	Set "1", UART use of RSCI module (r_rsci_rx).			
TOUCH_CFG_UART_NUMBER	Set the UART channel number.			
TOUCH_CFG_UART_BAUDRATE	Set the UART Baudrate.			
TOUCH_CFG_UART_PRIORITY	Set the UART interrupt priority.			
TOUCH_CFG_CHATTERING_SUPPRESSION_TYPE	Set the chattering suppression type.			
*Default value: "0"	Set "0", it is set to TypeA. The counter of the number of times the			
	threshold is exceeded is held within the hysteresis range.			
	Set "1", it is set to TypeB. Resets the counter of the number of times			
	the threshold is exceeded within the hysteresis range.			
The following configurations depend on the touch interface configuration and cannot be set using Smart Configurator.				
These configurations are set when using QE. In this case, QE_TOUCH_CONFIGURATION is defined in the project.				
Although rm_touch_config.h is invalid, qe_touch_de	I			
CTSU_CFG_NUM_BUTTONS	Sets the total number of buttons.			
CTSU_CFG_NUM_SLIDERS	Sets the total number of slides.			
CTSU_CFG_NUM_WHEELS	Sets the total number of wheels.			

2.8 Code Size

ROM (code and constants) and RAM (global data) size are determined according to the configuration options as described in "section 2.7 Compilation Setting" during a build. The values shown are reference values when the compile option is the default for C compiler listed in "section 2.3 Supported Toolchains". The default of compile options is as follows: the optimization level is 2, the optimization type is size priority, and the data-endian is a little endian. The code size varies according to the C compile version and the compile options.

ROM and RAM Usage the configuration options with Self-capacitance 1 button (VMM)			
TOUCH_CFG_PARAM_CHECKING_ENABLE 0	ROM: 1204byte		
TOUCH_CFG_MONITOR_ENABLE 0	DAM column		
TOUCH_CFG_UART_MONITOR_SUPPORT 0	RAM: 29byte		

ROM and RAM Usage Size of each mode, amount of increase by adding(VMM)						
	Self- capacitance	+Self- capacitance	+Wheel	+Slider	Mutual- capacitance	+Mutual- capacitance
	button 1	button			button 1	button
ROM	1204 bytes	+0 bytes	+373 bytes	+424 bytes	1290 bytes	+0 bytes
RAM	29 bytes	+24 bytes	+13 bytes	+15 bytes	31 bytes	+26 bytes

ROM and RAM Usage the configuration options with Self-capacitance 1 button (JMM)			
TOUCH_CFG_PARAM_CHECKING_ENABLE 0	ROM: 1460 bytes		
TOUCH_CFG_MONITOR_ENABLE 0	DAM: CO history		
TOUCH_CFG_UART_MONITOR_SUPPORT 0	RAM: 69 bytes		

	ROM and RAM Usage Size of each mode, amount of increase by adding(JMM)					
	Self-capacitance button 1	+Self- capacitance	+Wheel	+Slider	Mutual- capacitance	+Mutual- capacitance
		button			button 1	button
ROM	1460 bytes	+0 bytes	_	_	1518 bytes	+0 bytes
RAM	69 bytes	+64 byte	_	_	75 bytes	+70 bytes

2.9 Arguments

The following is the structures and enums used as arguments of the API functions. Many of the parameters used in the API functions are defined by the enums, which provides a way to check types and reduce errors. These structures and enums are defined in rm_touch_qe.h, rm_touch_qe_api.h along with the prototype declaration.

The control structure for the touch interface configuration are shown in Table 2 touch_ctrl_t Structure. Please refer rm_touch_qe.h to see data type used in this structure. Using QE for Capacitive Touch allows the variables corresponding to the touch interface configuration to be output by qe_touch_config.c. Make sure to set qe_touch_config.c in the module's first API argument.

Data Type Member Description uint32_t Open flag open **Button information** touch_button_info_t binfo Slider information touch_slider_info_t sinfo Wheel information touch_wheel_info_t winfo serial_tuning_enable Flag for enabling serial tuning bool touch_cfg_t const * p_touch_cfg Pointer to the configuration structure ctsu_instance_t const * p_ctsu_instance Pointer to the CTSU control structure Pointer to the structure for majority touch_mm_info_t p_touch_mm_info judgment

Table 2 touch ctrl t Structure

The touch_button_info_t structure is shown below. It manages the results of touch judgement and the data required for touch judgement for each button.

Data Type	Member	Description	
uint64_t	status	Results of touch judgement for the button	
uint16_t *	p_threshold	Pointer to the threshold buffer	
uint16_t *	p_hysteresis	Pointer to the hysteresis buffer	
uint16_t *	p_reference	Pointer to the reference value buffer	
uint16	n en count	Number of times the threshold for judging that	
uint16_t *	p_on_count	the button is being touched was exceeded	
uint16_t *	p_off_count	Threshold	
uint32_t *	p_drift_buf	Pointer to the drift buffer	
uint16_t *	p_drift_count	Pointer to the drift count buffer	
uint8_t	on_freq	Judgement count of positive noise filtering	
uint8_t	off_freq	Judgement count of negative noise filtering	
uint16_t	drift_freq	"Drift Correction Interval"	
uint16_t	cancel_freq	"Long Press Cancel Count"	

Table 3 touch_button_info_t Structure

The touch_slider_info_t structure is shown below. It manages the results of position detection and threshold for each slider.

Table 4 touch_slider_info_t Structure

Data Type	Member	Description
uint16_t *	p_position	Pointer to the position result buffer
uint16_t * p_threshold		Pointer to the threshold buffer

The touch_wheel_info_t structure is shown below. It manages the results of position detection and threshold for each wheel.

Table 5 touch_wheel_info_t Structure

Data Type	Member	Description
uint16_t *	p_position	Pointer to the position result buffer
uint16_t * p_threshold		Pointer to the threshold buffer

Table 6 shows touch_cfg_t structure (configuration structure).

Using QE for Capacitive Touch allows the variables corresponding to the touch interface configuration to be output by qe_touch_config.c and set this structure to the second argument of RM_TOUCH_Open() function. The value of this structure is assumed to be set by Smart Configurator or QE for Capacitive Touch and no error check is conducted due to streamline the process. Be careful when setting the value of this structure manually.

Table 6 touch_cfg_t Structure

Data Type	Member Name	Description	Range of the Value
touch_button_cfg_t *	p_buttons	Pointer to a button configuration	_
touch_slider_cfg_t *	p_sliders	Pointer to a slider configuration	_
touch_wheel_cfg_t *	p_wheels	Pointer to a wheel configuration	_
touch_pad_cfg_t *	p_pad	Pointer to a pad configuration	_
uint8_t	num_buttons	Number of buttons	0 to 64
uint8_t	num_sliders	Number of sliders	0 or 7
uint8_t	num_wheels	Number of wheels	0 or 7
uint8_t	on_freq	Accumulated number of touch-ON judgements	0 to 255 (0 disable positive noise filter)
uint8_t	off_freq	Accumulated number of touch-OFF judgements	0 to 255 (0 disable negative noise filter)
uint16_t	drift_freq	Number of cycles for drift correction of the reference value	0 to 65535 (0 disables drift correction.)
uint16_t	cancel_freq	Maximum number of consecutive touch-ON judgements	0 to 65535 (0 disables long-press cancellation)
uint8_t	number	Configuration number for QE monitoring	0 to 255
ctsu_instance_t *	p_ctsu_instance	CTSU instance pointer	
void *	p_context	Context pointer	
void *	p_extend	Extended configuration pointer	_

Table 7 touch_button_cfg_t Structure

Data Type	Member Name	Description	Range of the Value
uint8_t	elem_index	Index of a button element 0 to 63	
uint16_t	threshold	Touch threshold 1 to 65535	
uint16_t	hysteresis	Hysteresis value for debouncing 0 to 65534	

Table 8 touch_slider_cfg_t Structure



uint8_t *	p_elem_index	Pointer to index of a slider element	-
uint8_t	num_elements	Number of elements used in the slider	1 to 10
uint16_t threshold		Threshold for position calculation	1 to 65535

Table 9 touch_wheel_cfg_t Structure

Data Type	Member Name	Description	Range of the Value
uint8_t *	p_elem_index	Pointer to index of a wheel element -	
uint8_t	num_elements	Number of elements used in the wheel	1 to 8
uint16_t	threshold	Threshold for position calculation 1 to 65535	

2.10 Return Values

The following provides return values for the API functions. The enum is defined in fsp common api.h.

```
/** Common error codes */
  typedef enum e_fsp_err
      FSP\_SUCCESS = 0,
      FSP_ERR_ASSERTION
                                                               ///< A critical assertion has failed
                                    = 2,
                                                               ///< Pointer points to invalid memory location
      FSP_ERR_INVALID_POINTER
      FSP ERR INVALID ARGUMENT
                                    = 3.
                                                               ///< Invalid input parameter
      FSP_ERR_NOT_OPEN
                                    = 7.
                                                               ///< Requested channel is not configured or API not open
      FSP_ERR_ALREADY_OPEN
                                                               ///< Requested channel is already open in a different
configuration
      FSP_ERR_INVALID_HW_CONDITION = 27,
                                                               ///< Detected hardware is in invalid condition
      /* Start of CTSU Driver specific */
      FSP_ERR_CTSU_SCANNING
                                         = 6000
                                                        ///< Scanning.
                                                        ///< Not processed previous scan data.
      FSP ERR CTSU NOT GET DATA
                                         = 6001.
      FSP_ERR_CTSU_INCOMPLETE_TUNING
                                         = 6002,
                                                        ///< Incomplete initial offset tuning.
                                                        ///< Diagnosis of data collected no yet.
      FSP_ERR_CTSU_DIAG_NOT_YET
                                         = 6003.
      FSP_ERR_CTSU_DIAG_LDO_OVER_VOLTAGE = 6004,
                                                        ///< Diagnosis of LDO over voltage failed.
                                                        ///< Diagnosis of CCO into 19.2uA failed.
      FSP_ERR_CTSU_DIAG_CCO_HIGH
                                         = 6005,
      FSP_ERR_CTSU_DIAG_CCO_LOW
                                         = 6006,
                                                        ///< Diagnosis of CCO into 2.4uA failed.
      FSP_ERR_CTSU_DIAG_SSCG
                                         = 6007,
                                                        ///< Diagnosis of SSCG frequency failed.
      FSP_ERR_CTSU_DIAG_DAC
                                          = 6008,
                                                        ///< Diagnosis of non-touch count value failed.
      FSP_ERR_CTSU_DIAG_OUTPUT_VOLTAGE
                                        = 6009,
                                                        ///< Diagnosis of LDO output voltage failed.
      FSP_ERR_CTSU_DIAG_OVER_VOLTAGE
                                         = 6010.
                                                        ///< Diagnosis of over voltage detection circuit failed.
      FSP_ERR_CTSU_DIAG_OVER_CURRENT
                                         = 6011,
                                                        ///< Diagnosis of over current detection circuit failed.
      FSP_ERR_CTSU_DIAG_LOAD_RESISTANCE = 6012,
                                                        ///< Diagnosis of LDO internal resistance value failed.
      FSP_ERR_CTSU_DIAG_CURRENT_SOURCE
                                         = 6013,
                                                        ///< Diagnosis of Current source value failed.
      FSP_ERR_CTSU_DIAG_SENSCLK_GAIN
                                         = 6014.
                                                        ///< Diagnosis of SENSCLK frequency gain failed.
      FSP_ERR_CTSU_DIAG_SUCLK_GAIN
                                         = 6015.
                                                        ///< Diagnosis of SUCLK frequency gain failed.
      FSP_ERR_CTSU_DIAG_CLOCK_RECOVERY
                                         = 6016,
                                                        ///< Diagnosis of SUCLK clock recovery function failed.
      FSP_ERR_CTSU_DIAG_CFC_GAIN
                                          = 6017,
                                                        ///< Diagnosis of CFC oscillator gain failed.
} fsp_err_t;
```

2.11 Adding the FIT Module to Your Project

2.11.1 Adding source tree and project include paths

This module must be added to each project in which it is used. Renesas recommends using "Smart Configurator" described in (1) or (3). However, "Smart Configurator" only supports some RX devices. Please use the methods of (2) or (4) for unsupported RX devices.

- (1) Adding the FIT module to your project using "Smart Configurator" in e2 studio
 By using the "Smart Configurator" in e2 studio, the FIT module is automatically added to your
 project. Refer to "Renesas e2 studio Smart Configurator User Guide (R20AN0451)" for details.
- (2) Adding the FIT module to your project using "FIT Configurator" in e2 studio
 By using the "FIT Configurator" in e2 studio, the FIT module is automatically added to your project.
 Refer to "Adding Firmware Integration Technology Modules to Projects (R01AN1723)" for details.
- (3) Adding the FIT module to your project using "Smart Configurator" on CS+
 By using the "Smart Configurator Standalone version" in CS+, the FIT module is automatically
 added to your project. Refer to "Renesas e2 studio Smart Configurator User Guide (R20AN0451)"
 for details.
- (4) Adding the FIT module to your project in CS+ In CS+, please manually add the FIT module to your project. Refer to "Adding Firmware Integration Technology Modules to CS+ Projects (R01AN1826)" for details.

2.11.2 Setting driver options when not using Smart Configurator

The Touch-specific options are found and edited in r_config¥r_touch_qe_config.h.

2.12 API compatibility mode

The API function has been completely revised in Rev.2.00.

An API compatibility mode is provided to use the Rev.1.11 API.

Please output the code of API compatibility mode when outputting the code in QE. Check the code output option "Use API compatibility mode" in QE and click the "File output" button to output the code for API compatibility mode.

Please refer to QE Touch Module Firmware Integration Technology Rev.1.11 (R01AN4470JU0111) for the API of Rev.v1.11.

API compatibility mode does not support the error detection of QE_ERR_OT_WINDOW_SIZE that was detected by R_TOUCH_Open ().



3. API Functions

3.1 RM_TOUCH_Open

This function initializes the module and must be executed before using any of the other API functions. Please execute this function for each touch interface configuration.

Format

Parameters

p_ctrl: Pointer to the control structurep_cfg: Pointer to the config structure

Return Values

```
FSP_SUCCESS /* Successfully completed */
FSP_ERR_ASSERTION /* Argument pointer not specified */
FSP_ERR_ALREADY_OPEN /* Open() is called without calling Close() */
FSP_ERR_INVALID_ARGUMENT /* Configuration parameters are invalid */
```

Properties

Prototype is declared in rm_touch_api.h .

Description

This function enables control structure initialization, calls R_CTSU_Open(), and initializes the CTSU module according to the argument p_cfg.

By setting TOUCH_CFG_MONITOR_ENABLE, the monitor buffer is initialized. By setting TOUCH CFG UART MONITOR SUPPORT, the UART monitor and UART module are initialized.

Example

```
fsp_err_t err;

/* Initialize pins (function created by Smart Configurator) */
R_CTSU_PinSetInit();

/* Initialize the API. */
err = RM_TOUCH_Open(&g_touch_ctrl, &g_touch_cfg);

/* Check for errors. */
if (err != FSP_SUCCESS)
{
    . . .
}
```

Special Notes:

The port must be initialized before calling this function. We recommend using the R_CTSU_PinSetInit() function generated by SmartConfigurator as the port initialization function.

This function calls the CTSU module's R_CTSU_Open(). Please refer R_CTSU_Open() for more details.

3.2 RM_TOUCH_ScanStart

This function starts measurement of the specified touch interface configuration.

Format

```
fsp_err_t RM_TOUCH_ScanStart (touch_ctrl_t * const p_ctrl)
```

Parameters

p_ctrl: Pointer to the control structure

Return Values

```
FSP_SUCCESS /* Successfully completed */
FSP_ERR_ASSERTION /* Argument pointer not specified */
FSP_ERR_NOT_OPEN /* Called without calling Open() */
FSP_ERR_CTSU_ERR_SCANNING /* Now scanning */
FSP_ERR_CTSU_NOT_GET_DATA /* Did not obtain previous results */
```

Properties

Prototype is declared in rm_touch_api.h.

Description

This function calls R_CTSU_ScanStart() and starts the measurement.

Example

```
fsp_err_t err;

/* Initiate a sensor scan by software trigger */
err = RM_TOUCH_ScanStart(&g_touch_ctrl);

/* Check for errors. */
if (err != FSP_SUCCESS)
{
    . . .
}
```

Special Notes:

This function calls the CTSU module's R_CTSU_ScanStart(). Refer the R_CTSU_ScanStart() document for more details.

3.3 RM TOUCH DataGet

This function reads the specified touch interface configuration.

Format

Parameters

- p_ctrl: Pointer to the control structure
- p button status: Pointer to the buffer that stores button state.
- p_slider_position: Pointer to the buffer that stores slider position.
- p_wheel_position: Pointer to the buffer that stores wheel position.

Return Values

```
FSP_SUCCESS /* Successfully completed */
FSP_ERR_ASSERTION /* Argument pointer not specified */
FSP_ERR_NOT_OPEN /* Called without calling Open() */
FSP_ERR_CTSU_SCANNING /* Now scanning */
FSP_ERR_CTSU_NOT_GET_DATA /* Did not obtain previous results */
FSP_ERR_CTSU_INCOMPLETE_TUNING /* Tuning initial offset */
FSP_ERR_INVALID_HW_CONDITION /* Values scanned by CTSU show abnormal values */
```

Properties

Prototype is declared in rm touch api.h.

Description

This function calls R_CTSU_DataGet() and reads all measured values from the previous measurement to determine the touch/non-touch state or position. By setting TOUCH_CFG_MONITOR_ENABLE, data is stored in the monitor buffer. By setting TOUCH_CFG_UART_MONITOR_SUPPORT, the data in the monitor buffer is sent to the UART module.

Example:

```
fsp_err_t err;
uint64_t button_status;
uint16_t slider_position[TOUCH_CFG_NUM_SLIDERS];
uint16_t wheel_position[TOUCH_CFG_NUM_WHEELS];

/* Get all sensor values */
err = RM_TOUCH_DataGet(&g_touch_ctrl, &button_status, slider_position,
wheel_position);
```

Special Notes:

This function calls the CTSU module's R_CTSU_DataGet(). Refer the R_CTSU_DataGet() document for more details.

3.4 RM TOUCH CallbackSet

This function sets the function specified for the measurement completion callback function.

Format

Parameters

p_api_ctrl: Pointer to the control structure
p_callback: Pointer to callback function

p_context: Pointer to send to callback function

p_callback_memory: Set to NULL

Return Values

```
FSP_SUCCESS /* Successfully completed */
FSP_ERR_ASSERTION /* Argument pointer not specified */
FSP_ERR_NOT_OPEN /* Called without calling Open() */
```

Properties

Prototype is declared in rm_touch_api.h.

Description

This function calls R_CTSU_CallbackSet() and sets the callback function.

Example:

```
fsp_err_t err;

/* Set callback function */
err = RM TOUCH CallbackSet(&g ctsu ctrl, ctsu callback, NULL, NULL);
```

Special Notes:

This function calls the CTSU module's R_CTSU_CallbackSet(). Refer the R_CTSU_CallbackSet() document for more details.

3.5 RM_TOUCH_Close

This function closes the specified touch interface configuration.

Format

```
fsp_err_t RM_TOUCH_Close (touch_ctrl_t * const p_ctrl)
```

Parameters

p_ctrl: Pointer to the control structure

Return Values

```
FSP_SUCCESS /* Successfully completed */
FSP_ERR_ASSERTION /* Argument pointer not specified */
FSP_ERR_NOT_OPEN /* Called without calling Open() */
```

Properties

Prototype is declared in rm_touch_api.h.

Description

This function closes the specified touch interface configuration.

Example:

```
fsp_err_t err;

/* Shut down peripheral and close driver */
err = RM_TOUCH_Close(&g_touch_ctrl);
```

Special Notes:

This function calls the CTSU module's R_CTSU_Close(). Refer the R_CTSU_Close() document for more details

3.6 RM_TOUCH_ScanStop

This function stops measuring the specified touch interface configuration.

Format

```
fsp_err_t RM_TOUCH_ScanStop (touch_ctrl_t * const p_ctrl)
```

Parameters

p_ctrl: Pointer to the control structure

Return Values

```
FSP_SUCCESS /* Successfully completed */
FSP_ERR_ASSERTION /* Argument pointer not specified */
FSP_ERR_NOT_OPEN /* Called without calling Open() */
```

Properties

Prototype is declared in rm_touch_api.h.

Description

This function stops measuring the specified touch interface configuration.

Example:

```
fsp_err_t err;
/* Stop CTSU module */
err = RM_TOUCH_ScanStop(&g_touch_ctrl);
```

Special Notes:

This function calls the CTSU module's R_CTSU_ScanStop(). Refer the R_CTSU_ScanStop() document for more details

3.7 RM_TOUCH_SensitivityRatioGet

This function returns the ratio of the current touch sensitivity to the touch sensitivity during tuning for the specified touch interface configuration.

Format

Parameters

p_ctrl: Pointer to the control structure

p modifier: Pointer to the variable storing table information of touch sensitivity ratio calculation

Return Values

```
FSP_SUCCESS /* Successfully got the ratio of touch sensitivity */
FSP_ERR_INVALID_POINTER /* Pointing to the invalid memory location */
FSP_ERR_CTSU_NOT_GET_DATA /* Did not obtain previous results */
FSP_ERR_CTSU_INCOMPLETE_TUNING /* Tuning initial offset */
```

Properties

Prototyped in file rm_touch_api.h.

Description

Estimate change of touch by threshold and threshold ratio and returns the ratio of change in response to tuning by assuming the change of touch is 100%.

Create the buffer for the number of button elements because this function outputs the ratio of change in current measurement to all selected touch interfaces, so set the start address of created buffer to p_touch_sensitibity_info->p_touch_sensitivity_ratio.

Example:

```
qe_err_t err;
touch_sensitivity_info_t touch_sensitivity_table[QE_NUM_METHODS];
uint16_t touch_sensitivity_first[CONFIG01_NUM_BUTTONS] = { 100 };

touch_sensitivity_table[QE_METHOD_CONFIG01].p_touch_sensitivity_ratio =
touch_sensitivity_first;
touch_sensitivity_table[QE_METHOD_CONFIG01].old_threshold_ratio = 60;
touch_sensitivity_table[QE_METHOD_CONFIG01].new_threshold_ratio = 70;
touch_sensitivity_table[QE_METHOD_CONFIG01].new_hysteresis_ratio = 5;

err = RM_TOUCH_SensitivityRatioGet(g_qe_touch_instance_config01.p_ctrl,
&touch_sensitivity_table[QE_METHOD_CONFIG01]);
```

Special Notes:

Call this function after obtain the measurement value of touch-on state by RM_TOUCH_DataGet().

3.8 RM_TOUCH_ThresholdAdjust

This function adjusts the thresholds for judging the state of touch and hysteresis for the specified touch interface configuration.

Format

Parameters

p_ctrl: Pointer to the control structure

p_modifier: Pointer to the variable storing table information of touch sensitivity ratio calculation

Return Values

```
FSP_SUCCESS /* Successfully changed touch determination threshold. */
FSP_ERR_INVALID_POINTER /* Pointing to the invalid memory location */
FSP_ERR_INVALID_ARGUMENT /* Configuration parameters are invalid */
```

Properties

Prototyped in file rm touch api.h.

Description

This function adjusts the threshold and hysteresis as ratio of change in ratio of touching(each button), new threshold ratio, old threshold ratio and new hysteresis ratio are inputted.

Example:

```
qe_err_t err;
touch_sensitivity_info_t touch_sensitivity_table[QE_NUM_METHODS];
uint16_t touch_sensitivity_first[CONFIG01_NUM_BUTTONS] = { 100 };

touch_sensitivity_table[QE_METHOD_CONFIG01].p_touch_sensitivity_ratio = touch_sensitivity_first;
touch_sensitivity_table[QE_METHOD_CONFIG01].old_threshold_ratio = 60;
touch_sensitivity_table[QE_METHOD_CONFIG01].new_threshold_ratio = 70;
touch_sensitivity_table[QE_METHOD_CONFIG01].new_hysteresis_ratio = 5;

err = RM_TOUCH_SensitivityRatioGet(g_qe_touch_instance_config01.p_ctrl,
&touch_sensitivity_table[QE_METHOD_CONFIG01]);

err = RM_TOUCH_ThresholdAdjust(g_qe_touch_instance_config01.p_ctrl,
&touch_sensitivity_table[QE_METHOD_CONFIG01]);
```

Special Notes:

None.

3.9 RM TOUCH DriftControl

This function changes the settings of drift correction for the specified touch interface configuration.

Format

Parameters

p_ctrl: Pointer to the control structure
input_drift_freq: Enables / disables interval of drift correction

Return Values

```
FSP_SUCCESS /* Successfully changed drift correction */
FSP_ERR_ASSERTION /* Missing required argument pointer */
```

Properties

Prototyped in file rm_touch_api.h.

Description

Set the drift correction to the number of times set in input_drift_freq. When a value other than 0 is set, the drift correction function is enabled. If set to 0, the drift correction function is disabled.

As an example of using this API, when calculating the ratio of the touch change amount using RM_TOUCH_SensitivityRatioGet (), the touch change amount decreases due to the thick overlay, and the threshold value is not exceeded even if touched. Prevents the reference value from drifting.

Example:

```
qe_err_t err;
err = RM_TOUCH_DriftControl(g_qe_touch_instance_config01.p_ctrl, 0);
```

3.10 RM TOUCH MonitorAddressGet

This function gets the address of the variable used by the QE monitor for the specified touch interface configuration.

Format

Parameters

p_ctrl: Pointer to the control structure

p_monitor_buf: Pointer to a variable that stores the start address of the monitor

p_monitor_id: Pointer to a variable that stores the address of the monitor ID variable

p_monitor_size: Pointer to a variable that stores the start address of the monitor size

Return Values

```
FSP_SUCCESS /* Successfully QE monitor variable address was got */
FSP_ERR_ASSERTION /* Null pointer passed as a parameter */
FSP_ERR_NOT_OPEN /* Module is not open */
FSP_ERR_NOT_ENABLED /* Requested operation is not enabled */
```

Properties

Prototyped in file rm_touch_api.h.

Description

Use this feature for the QE monitor when you have both automatic judgement and software judgement touch interface configurations. Get the start address of the monitor buffer with the second argument, the address of the monitor ID variable with the third argument, and the start address of the monitor size with the fourth argument.

Example:

Special Notes:

This function is for QE monitoring features.

Revision History

		Description		
Rev.	Date	Page	Summary	
1.00	Oct.04.18	_	First edition issued	
1.10	Jul.09.19	1,39	Added RX23W support	
		4-6	Added definitions for "correction" and "offset tuning".	
		15, 18, 22,	Updated API return values	
		30, 31	ALL LITOURIL OND RET FAILED RENDOR	
		24, 26	Added TOUCH_CMD_GET_FAILED_SENSOR and TOUCH_CMD_GET_LAST_SCAN_METHOD Control()	
			commands	
		*	Moved offset tuning processing into R_TOUCH_Open().	
		14, 16-20	Added #pragma section macros and configuration option to	
		1 .,	driver for Safety Module support (includes GCC/IAR support).	
		1,20	Added IEC 6730 Compliance section.	
		15,22	Added error code QE_ERR_UNSUPPORTED_CLK_CFG.	
1.11	Jan.09.20	30-31	Updated example code.	
		29,32	Added TOUCH_CMD_CLEAR_TOUCH_STATES for	
			low power applications.	
		5,6,22,35	Added API function R_TOUCH_GetBtnBaselines().	
		_	Fixed bug (CTSU) where a custom callback function was called twice after a scan completes.	
			Fixed compile error (CTSU) for RX231 when PLL had multiplier	
			of 13.5.	
2.00	Jul.30.21	-	Full-fledged revision	
2.01	Dec.17.21	7	Fixed 1.2 API Overviews	
		10	Fixed 2.8 Code Size	
2.10	Apr.20.22	7	Fixed 1.2 API Overviews	
		29,30	Added 3.10 RM_TOUCH_MonitorAddressGet	
2.20	Dec.28.22	4	Added to 1.13 Button touch detection	
		9	Updated 2.2 Software requirements	
		9	Updated 2.3 Supported toolchains	
		11	Fixed 2.8 Code size	
		13 18	Updated 2.10 return value Updated 3.3 R_TOUCH_DataGet	
3.00	Oct.15.24	1	Added RX260, RX261 support	
3.00	001.10.24	3	Updated 1.1.2 Measurements and Data Processing	
		6	Updated 1.1.5 Tuning the Touch Determination Threshold	
		8		
			Updated 2.1 Hardware requirements	
		8	Updated 2.2 Software requirements	
		8	Updated 2.3 Supported toolchains	
		9	Updated 2.7 Compilation Settings	
		9	Updated 2.8 Code Size	
		12	Updated 2.9 Arguments	
		22	Updated Description of 3.7 RM_TOUCH_SensitivityRatioGet	
		23	Updated Description of 3.8 RM_TOUCH_ThresholdAdjust	
			-	

General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Precaution against Electrostatic Discharge (ESD)

A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.

Processing at power-on

The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power reaches the level at which resetting is specified.

3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

4. Handling of unused pins

Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.

5. Clock signals

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.

Voltage application waveform at input pin

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between V_{IL} (Max.) and V_{IH} (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between V_{IL} (Max.) and V_{IH} (Min.).

Prohibition of access to reserved addresses

Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not quaranteed.

8. Differences between products

Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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